

# FDD86102 N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 36 A, 24 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 24 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 8 A
- Max  $r_{DS(on)}$  = 38 m $\Omega$  at  $V_{GS}$  = 6 V,  $I_D$  = 6 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

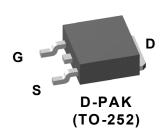


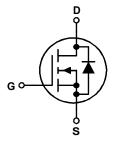
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been optimized for  $r_{\text{DS(on)}}$ , switching performance and ruggedness.

### Applications

DC - DC Conversion





### MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol		Parameter				Ratings		Units	
V <sub>DS</sub>	Drain to	Drain to Source Voltage				100		V	
V <sub>GS</sub>	Gate to	Gate to Source Voltage				±20		V	
ID	Drain Current -Continuous (Package limited) T <sub>C</sub> = 25 °C					42 36 8		A	
	-Continuous (Silicon limited) $T_C = 25 \degree C$								
	-Continuous T <sub>A</sub> = 25 °C (Note 1a)								
	-Pulsed					40	40		
E <sub>AS</sub>	Single P	Single Pulse Avalanche Energy (Note 3)			121		mJ		
P <sub>D</sub>	Power Dissipation $T_{C} = 25 \degree C$				62		W		
	Power D	Dissipation	T <sub>A</sub> =	25 °C	(Note 1a)	3.1		vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +150		°C		
Thermal Ch						2.0			
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case				2.0		°C/W		
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)				40				
Package Ma	arking a	nd Ordering Informa	tion						
Device Marking		Device	Package	Re	eel Size	Tape Width C		antity	
FDD86102		FDD86102	D-PAK(TO-252)		13 "	12 mm		2500 units	

©2009 Fairchild Semiconductor Corporation FDD86102 Rev.C2

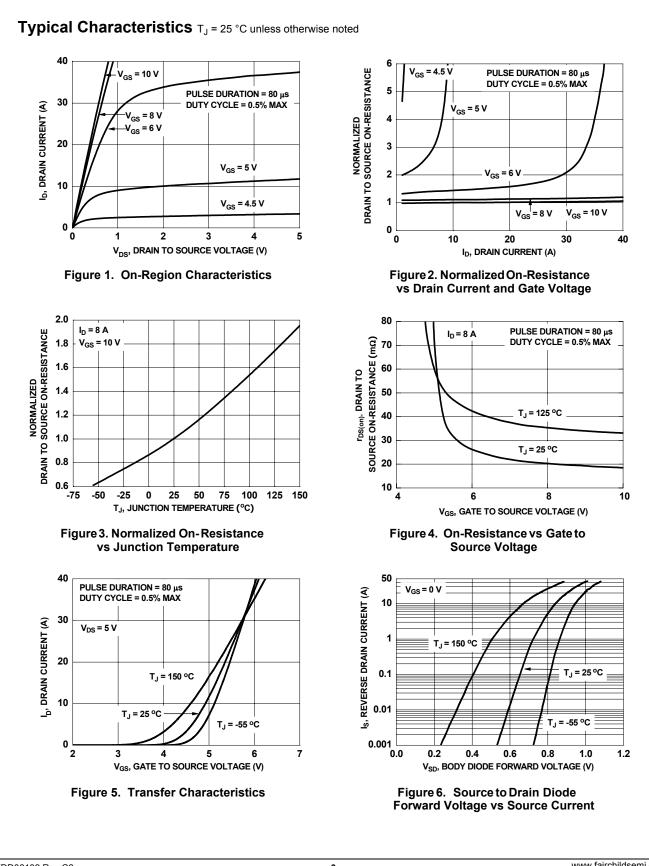
January 2010

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
3V <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V
ABV <sub>DSS</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		67		mV/°C
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	Cteristics (Note 2)		0	2.4	4	V
/ <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	3.1	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 250 $\mu$ A, referenced to 25 °C		-8.5		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		19	24	mΩ
DS(on)	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 6 A		26	38	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 8 A, T <sub>J</sub> = 125 °C		33	44	
JFS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 8 A		21		S
ynamic	Characteristics					
Piss	Input Capacitance	N 50 Y Y 0 Y		780	1035	pF
Soss	Output Capacitance	──V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		180	240	pF
Srss	Reverse Transfer Capacitance			15	25	pF
Rg	Gate Resistance			0.4		Ω
witching	g Characteristics					
d(on)	Turn-On Delay Time			7.6	15	ns
	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 8 A,		3.0	10	ns
d(off)	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		13.4	24	ns
f	Fall Time			2.9	10	ns
Σ <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		13.4	19	nC
λ <sup>g</sup>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		7.6	11	nC
λ <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 8 A		4.0		nC
λ <sup>gd</sup>	Gate to Drain "Miller" Charge			3.7		nC
-	urce Diode Characteristics					
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 8 A (Note 2)		0.8	1.3	
/ <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.7	1.2	V
rr	Reverse Recovery Time			43	68	ns
n 2 <sup>u</sup>	Reverse Recovery Charge	I <sub>F</sub> = 8 A, di/dt = 100 A/μs		43	68	nC
	m of the junction-to-case and case-to-ambient thermal resis nteed by design while R <sub>0JA</sub> is determined by the user's boa a. 40 °C/W when m 1 in <sup>2</sup> pad of 2 oz	ounted on a	b. 96 °C/V	er mounting s V when mour m pad of 2 o:	nted on a	e drain pins
	<ul> <li>ΦΦΦΦΦ</li> <li>ulse Width &lt; 300 μs, Duty cycle &lt; 2.0%.</li> <li>25°C, L = 3 mH, I<sub>AS</sub> = 9 A, V<sub>DD</sub> = 100 V, V<sub>GS</sub> = 10 V.</li> </ul>					

**Electrical Characteristics**  $T_J$  = 25 °C unless otherwise noted

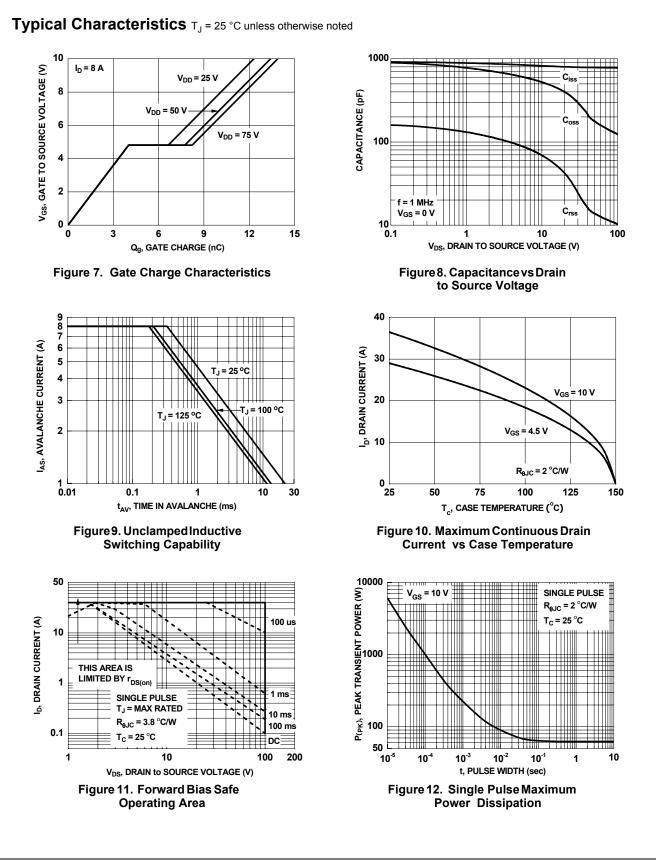
FDD86102 Rev.C2

FDD86102 N-Channel PowerTrench<sup>®</sup> MOSFET



FDD86102 Rev.C2

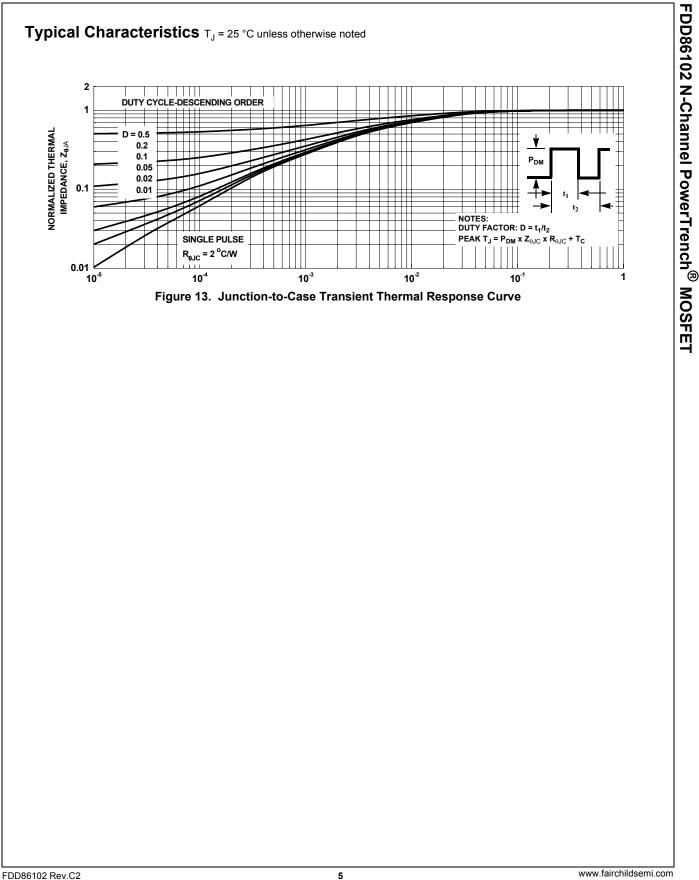
3



FDD86102 Rev.C2

4

FDD86102 N-Channel PowerTrench<sup>®</sup> MOSFET



Downloaded from Elcodis.com electronic components distributor

www.fairchildsemi.com

## FAIRCHIL

SEMICONDUCTOR

### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ Auto-SPM™ Build it Now™ CorePLUS™ CorePOWER™ CROSSVOLT™ CTI ™ Current Transfer Logic™ DEUXPEED EcoSPARK<sup>®</sup> EfficentMax™ EZSWITCH™\*



airchild® Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FastvCore™ FETBench™

FPS™ F-PFS™ FRFET® Global Power Resource<sup>SM</sup> Green FPS™ Green FPS™ e-Series™ Gmax™ GTO™ IntelliMAX™ ISOPLANAR™ MegaBuck™ MIČROCOUPLER™ MicroFET™ MicroPak™ MillerDrive™ MotionMax™ Motion-SPM™ OPTOLOGIC<sup>®</sup> **OPTOPLANAR<sup>®</sup>** R PDP SPM™

FlashWriter<sup>®</sup>\*

Power-SPM™ PowerTrench<sup>®</sup> PowerXS™ Programmable Active Droop™ OFFT QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ SPM<sup>®</sup> STEALTH™ SuperFET™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS™ SyncFET™ Sync-Lock™

**SYSTEM**<sup>®\*</sup> GENERAL The Power Franchise<sup>®</sup> bwer p franchise TinyBoost™

FDD86102 N-Channel PowerTrench<sup>®</sup> MOSFE

TinyBuck™ TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TriFault Detect™ TRUECURRENT™\* uSerDes™



UHC® Ultra FRFET™ UniFET™ VCX™ VisualMax™ XS™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are 1 intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed Full Production Datasheet contains make changes at a		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	-	Rev

FDD86102 Rev.C2

6